

## TC74VHCT374AF, TC74VHCT374AFT, TC74VHCT374AFK

### Octal D-Type Flip Flop with 3-State Output

The TC74VHCT374A is an advanced high speed CMOS OCTAL FLIP-FLOP with 3-STATE OUTPUT fabricated with silicon gate C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

This 8-bit D-type flip-flop is controlled by a clock input (CK) and an output enable input ( $\overline{OE}$ ).

When the  $\overline{OE}$  input is high, the eight outputs are in a high impedance state.

The input voltage are compatible with TTL output voltage.

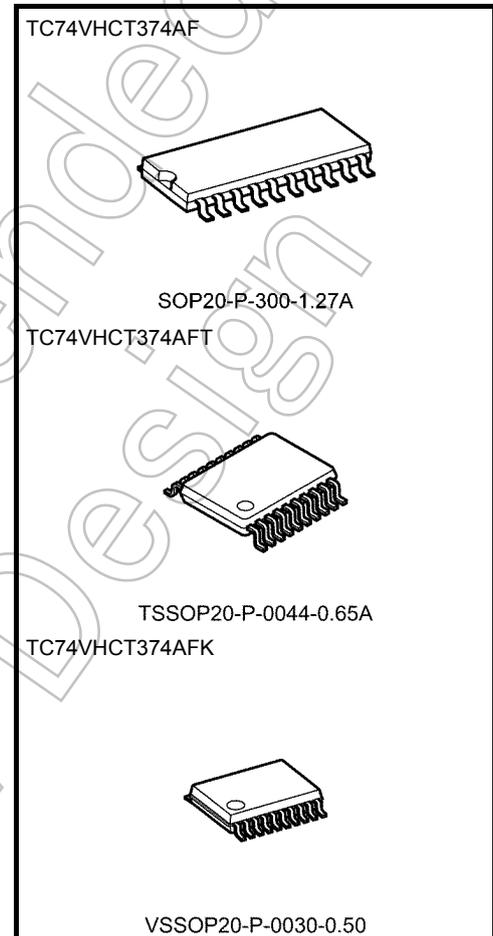
This device may be used as a level converter for interfacing 3.3 V to 5 V system.

Input protection and output circuit ensure that 0 to 5.5 V can be applied to the input and output (Note) pins without regard to the supply voltage. These structure prevents device destruction due to mismatched supply and input/output voltages such as battery back up, hot board insertion, etc.

Note: Output in off-state

### Features

- High speed:  $f_{max} = 140$  MHz (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 4$   $\mu$ A (max) at  $T_a = 25^\circ$ C
- Compatible with TTL inputs:  $V_{IL} = 0.8$  V (max)  
 $V_{IH} = 2.0$  V (min)
- Power down protection is provided on all inputs and outputs.
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Low noise:  $V_{OLP} = 1.5$  V (max)
- Pin and function compatible with the 74 series (74AC/HC/F/ALS/LS etc.) 374 type.

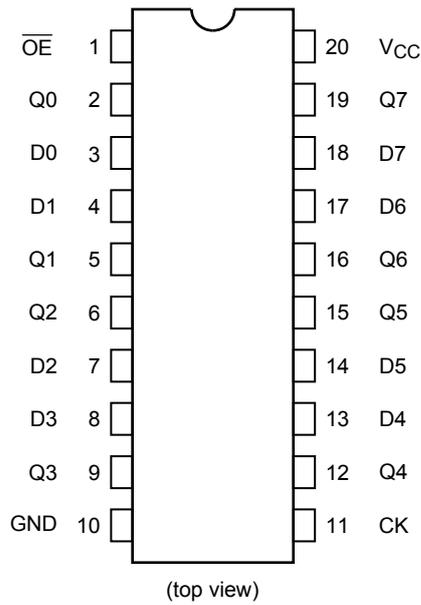


### Weight

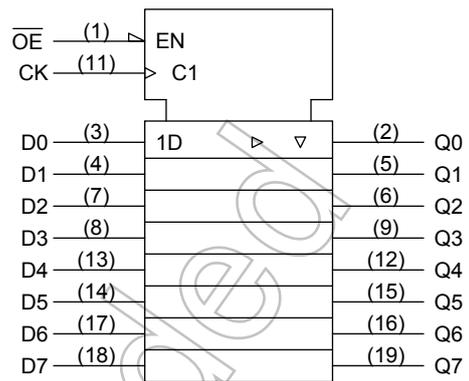
SOP20-P-300-1.27A:	0.22 g (typ.)
TSSOP20-P-0044-0.65A:	0.08 g (typ.)
VSSOP20-P-0030-0.50:	0.03 g (typ.)

Start of commercial production  
1995-12

## Pin Assignment



## IEC Logic Symbol



## Truth Table

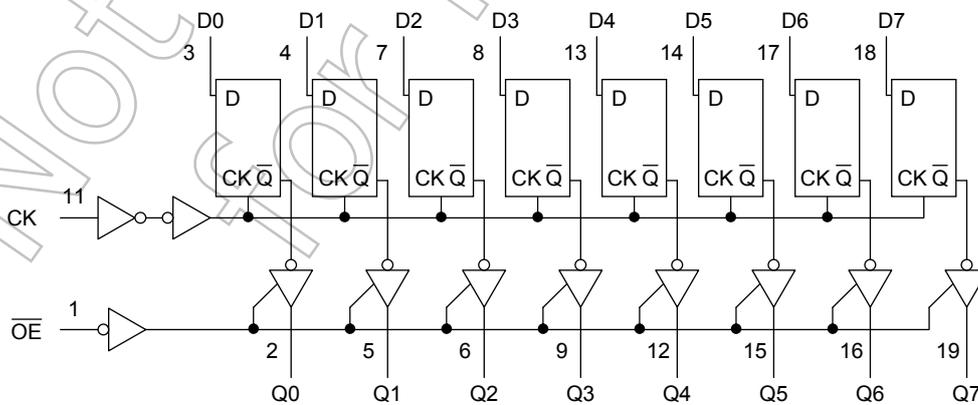
Inputs			Output
$\overline{OE}$	CK	D	
H	X	X	Z
L		X	Qn
L		L	L
L		H	H

X: Don't care

Z: High impedance

Qn: No change

## System Diagram



## Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	$V_{CC}$	-0.5 to 7.0	V
DC input voltage	$V_{IN}$	-0.5 to 7.0	V
DC output voltage	$V_{OUT}$	-0.5 to 7.0 (Note 2)	V
		-0.5 to $V_{CC} + 0.5$ (Note 3)	
Input diode current	$I_{IK}$	-20	mA
Output diode current	$I_{OK}$	$\pm 20$ (Note 4)	mA
DC output current	$I_{OUT}$	$\pm 25$	mA
DC $V_{CC}$ /ground current	$I_{CC}$	$\pm 75$	mA
Power dissipation	$P_D$	180	mW
Storage temperature	$T_{stg}$	-65 to 150	$^{\circ}C$

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: Output in off-state

Note 3: High or low state.  $I_{OUT}$  absolute maximum rating must be observed.

Note 4:  $V_{OUT} < GND$ ,  $V_{OUT} > V_{CC}$

## Operating Ranges (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage	$V_{CC}$	4.5 to 5.5	V
Input voltage	$V_{IN}$	0 to 5.5	V
Output voltage	$V_{OUT}$	0 to 5.5 (Note 2)	V
		0 to $V_{CC}$ (Note 3)	
Operating temperature	$T_{opr}$	-40 to 85	$^{\circ}C$
Input rise and fall time	$dt/dv$	0 to 20	ns/V

Note 1: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

Note 2:  $V_{CC} = 0$  V

Note 3: High or low state

## Electrical Characteristics

### DC Characteristics

Characteristics	Symbol	Test Condition		Ta = 25°C			Ta = -40 to 85°C		Unit	
				V <sub>CC</sub> (V)	Min	Typ.	Max	Min		Max
High-level input voltage	V <sub>IH</sub>	—		4.5 to 5.5	2.0	—	—	2.0	—	V
Low-level input voltage	V <sub>IL</sub>	—		4.5 to 5.5	—	—	0.8	—	0.8	V
High-level output voltage	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	4.5	4.40	4.50	—	4.40	—	V
			I <sub>OH</sub> = -8 mA	4.5	3.94	—	—	3.80	—	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 50 μA	4.5	—	0.0	0.10	—	0.10	V
			I <sub>OL</sub> = 8 mA	4.5	—	—	0.36	—	0.44	
3-state output off-state current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	—	—	±0.25	—	±2.50	μA
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 5.5 V or GND		0 to 5.5	—	—	±0.1	—	±1.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	—	—	4.0	—	40.0	μA
	I <sub>CCCT</sub>	Per input: V <sub>IN</sub> = 3.4 V Other input: V <sub>CC</sub> or GND		5.5	—	—	1.35	—	1.50	mA
Output leakage current	I <sub>OPD</sub>	V <sub>OUT</sub> = 5.5 V		0	—	—	0.5	—	5.0	μA

### Timing Requirements (input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Characteristics	Symbol	Test Condition		Ta = 25°C		Ta = -40 to 85°C	Unit
				V <sub>CC</sub> (V)	Typ.	Limit	
Minimum pulse width (CK)	t <sub>w</sub> (H)	—		5.0 ± 0.5	—	6.5	ns
	t <sub>w</sub> (L)	—		5.0 ± 0.5	—	8.5	
Minimum set-up time	t <sub>s</sub>	—		5.0 ± 0.5	—	2.5	ns
Minimum hold time	t <sub>h</sub>	—		5.0 ± 0.5	—	2.5	ns

**AC Characteristics (input:  $t_r = t_f = 3$  ns)**

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit		
			V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Typ.	Max		Min	Max
Propagation delay time (CK-Q)	t <sub>pLH</sub>	—	5.0 ± 0.5	15	—	4.1	9.4	1.0	10.5	ns
	t <sub>pHL</sub>			50	—	5.6	10.4	1.0	11.5	
3-state output enable time	t <sub>pZL</sub>	R <sub>L</sub> = 1 kΩ	5.0 ± 0.5	15	—	6.5	10.2	1.0	11.5	ns
	t <sub>pZH</sub>			50	—	7.3	11.2	1.0	12.5	
3-state output disable time	t <sub>pLZ</sub> t <sub>pHZ</sub>	R <sub>L</sub> = 1 kΩ	5.0 ± 0.5	50	—	7.0	11.2	1.0	12.0	ns
Maximum clock frequency	f <sub>max</sub>	—	5.0 ± 0.5	15	90	140	—	80	—	MHz
				50	85	130	—	75	—	
Output to output skew	t <sub>osLH</sub> t <sub>osHL</sub>	(Note 1)	5.0 ± 0.5	50	—	—	1.0	—	1.0	ns
Input capacitance	C <sub>IN</sub>	—	—	—	—	4	10	—	10	pF
Output capacitance	C <sub>OUT</sub>	—	—	—	—	9	—	—	—	pF
Power dissipation capacitance	C <sub>PD</sub>	—	—	(Note 2)	—	25	—	—	—	pF

Note 1: Parameter guaranteed by design.

$$t_{osLH} = |t_{pLHm} - t_{pLHn}|, t_{osHL} = |t_{pHLm} - t_{pHLn}|$$

Note 2: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

Average operating current can be obtained by the equation:

$$I_{CC (opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC} / 8 \text{ (per F/F)}$$

And the total C<sub>PD</sub> when n pcs. of latch operate can be gained by the following equation:

$$C_{PD (total)} = 14 + 11 \cdot n$$

**Noise Characteristics (input:  $t_r = t_f = 3$  ns)**

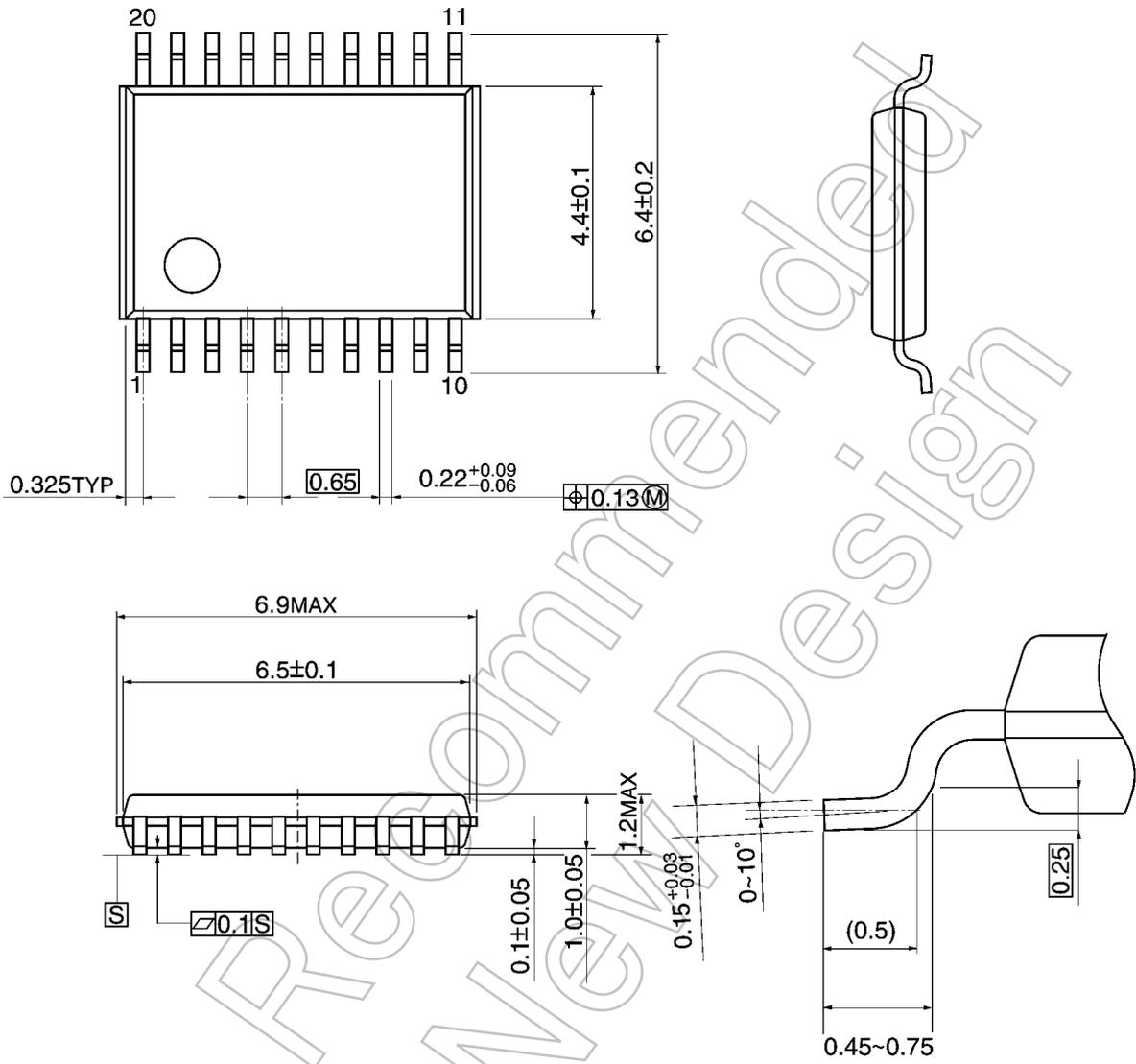
Characteristics	Symbol	Test Condition	Ta = 25°C			Unit
			V <sub>CC</sub> (V)	Typ.	Limit	
Quiet output maximum dynamic V <sub>OL</sub>	V <sub>OLP</sub>	C <sub>L</sub> = 50 pF	5.0	1.1	1.5	V
Quiet output minimum dynamic V <sub>OL</sub>	V <sub>OLV</sub>	C <sub>L</sub> = 50 pF	5.0	-1.1	-1.5	V
Minimum high level dynamic input voltage	V <sub>IHD</sub>	C <sub>L</sub> = 50 pF	5.0	—	2.0	V
Maximum low level dynamic input voltage	V <sub>ILD</sub>	C <sub>L</sub> = 50 pF	5.0	—	0.8	V



**Package Dimensions**

TSSOP20-P-0044-0.65A

Unit: mm

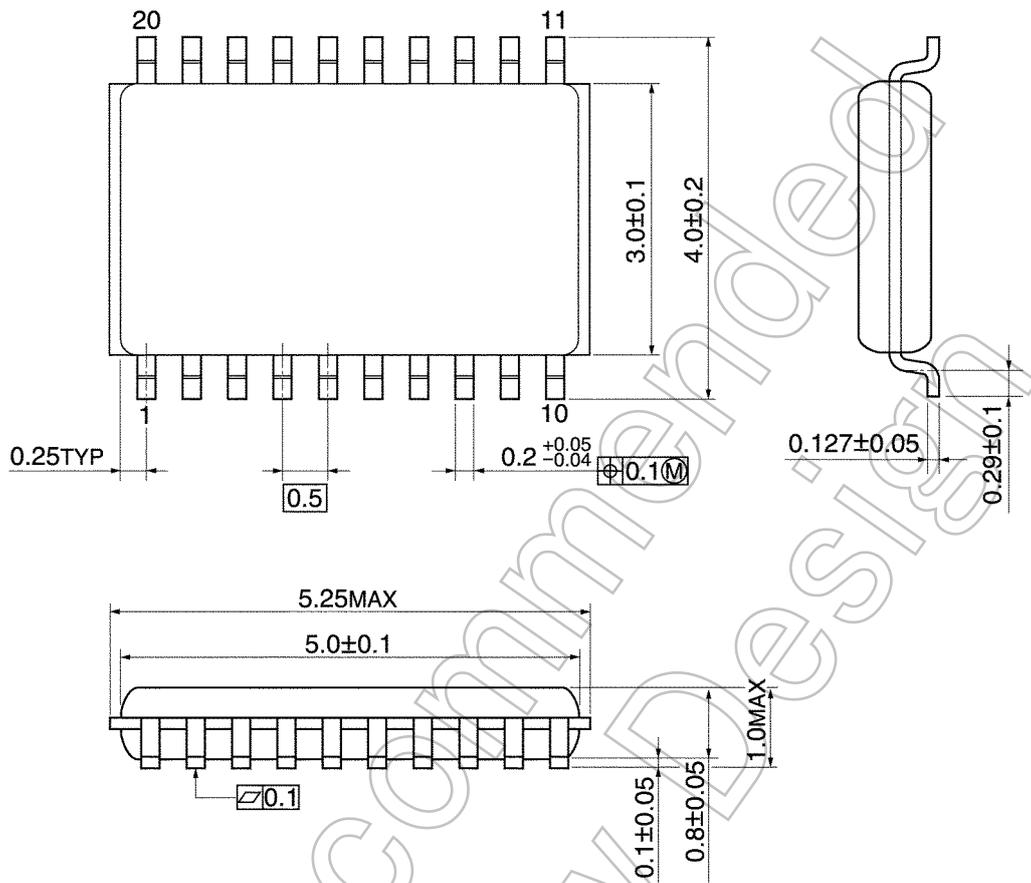


Weight: 0.08 g (typ.)

## Package Dimensions

VSSOP20-P-0030-0.50

Unit: mm



Weight: 0.03 g (typ.)

Not Recommended for New Designs

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